

### **Product/Process Change Notification**

N° PCN 2022-178-A

Dear customer,

please find attached our Infineon Technologies AG PCN:

Introduction of an additional wafer production and wafer test location at Infineon Technologies Dresden GmbH, Dresden, Germany and an additional wafer diameter for products IPD50N04S4-10, IPD75N04S4-06, IPB80N04S4-04, IPD100N04S4-02 and IPB180N04S4-00

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2023-01-30.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates:
  "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."
  Notwithstanding the aforesaid individual agreements shall prevail.

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

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Management Board Jochen Hanebeck (CEO), Constanze Hufenbecher, Dr. Sven Schneider, Andreas Urschitz, Dr. Rutger Wijburg Registered office Neubiberg Commercial register Amtsgericht München HRB 126492



# **Product/Process Change Notification**

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**Products affected** 

Please refer to attached affected product list PCN\_PCN 2022-178-A\_[customer-no].pdf

**Detailed change information** 

Subject: Introduction of an additional wafer production and wafer test location at Infineon Technologies Dresden GmbH, Dresden, Germany and an additional wafer diameter for products IPD50N04S4-10, IPD75N04S4-06, IPB80N04S4-04, IPD100N04S4-02 and IPB180N04S4-00

Reason/Motivation: Due to continuously raising demand for Infineon automotive products exceeding the capacity in Villach and Kulim we have to extend wafer production and wafer

Description	<u>Old</u>	New	
PROCESS - WAFER PRODUCTION: New	Infineon Technologies Austria AG,	Infineon Technologies Austria AG, Villach, Austria, 200mm AND	
wafer diameter	Villach, Austria, 200mm		
	AND		
	Kulim, Malaysia, 200mm	Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia, 200mm AND Infineon Technologies Dresden GmbH, Dresden, Germany, 300mm	
PROCESS - WAFER PRODUCTION: Move all or parts of production to a different wafer fab site.	Villach, Austria	Infineon Technologies Austria AG, Villach, Austria	
		AND	
	Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia	Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia	
	•	AND	
		Infineon Technologies Dresden GmbH,	
		Dresden, Germany	



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TEST FLOW: Move of all or part of Infineon Technologies Austria AG,

electrical wafer test and/or final test to Villach, Austria

a different test site. AND

Kulim, Malaysia

Infineon Technologies Austria AG,

Villach, Austria

AND

Infineon Technologies (Kulim) Sdn. Bhd., Infineon Technologies (Kulim) Sdn. Bhd.,

Kulim, Malaysia

Infineon Technologies Dresden GmbH,

Dresden, Germany

8 Inch: Wafer lot numbers from Villach start with VExxxxxx. **Product identification** 

8 Inch: Wafer lot numbers from Kulim start with with 1Exxxxxx or 1Fxxxxxx.

12 Inch: Wafer lot numbers from Dresden start with ZFxxxxxx.

Traceability assured via date code.

Based on the qualification performed, Infineon does not expect any negative **Anticipated impact of change** 

impact on quality, function and reliability.

DeQuMa-ID(s): SEM-PW-02 / SEM-PW-13 / SEM-TF-01

**Attachments** N\_PCN 2022-178-A\_[customer-no].pdf affected product list

#### Time schedule

Final qualification report	available
First samples available	on request
Intended start of delivery [1]	2023-04-30
Last order date (LOD) [2]	2023-06-30
Last delivery date (LDD) [3]	2024-06-30

<sup>[1]</sup> Provided date or earlier after customer approval.

If you have any questions, please do not hesitate to contact your local sales office.

<sup>[2]</sup> Last date where orders for unchanged products will be accepted.

<sup>[3]</sup> Last date for delivery of unchanged products. Delivery of changed products can be earlier (see Intended start of delivery) and depends on approval.

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Affected products sold to FUTURE ELECTRONICS INC. (4000624)

Sales name	SP number	OPN	Package	Customer part number
IPB180N04S4-00	SP000646176	IPB180N04S400ATMA 1	PG-TO263-7-3	IPB180N04S400ATMA1
IPB80N04S4-04		IPB80N04S404ATMA1		IPB80N04S404ATMA1
IPD100N04S4-02	SP000646184	IPD100N04S402ATMA 1	PG-TO252-3-313	IPD100N04S402ATMA1